# **Surface Mount Rectifiers,** 1 A, 400 V - 600 V

# S1GHE, S1JHE

#### **Features**

- Low Profile Package with < 0.75 mm Package Height
- High Efficiency
- Moisture Sensitivity Level 1 per J–STD–020
- Glass Passivated Chip Junction
- UL Flammability 94V–0 Classification
- Green Mold Compound
- NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

### **Specifications**

#### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted)

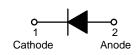
		Value	
Symbol	Parameter	S1GHE S1JHE	Unit
V <sub>RRM</sub>	Maximum Repetitive Peak Reverse Voltage	400 600	٧
I <sub>F(AV)</sub>	Maximum Average Forward Rectified Current	1	Α
I <sub>FSM</sub>	Peak Forward Surge Current, 8.3 ms Single Half Sine–Wave Superimposed on Rated Load	20	А
TJ	Operating Junction Temperature Range	-55 to +175	°C
T <sub>STG</sub>	Storage Temperature Range	-55 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



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#### Rectifier







### **MARKING DIAGRAM**



**Band Indicates Cathode** 

- &Y = Binary Calendar Year Coding Scheme
- = Assembly Plant Code &Z

&G

= Specific Device Code - (A5, A7)

## = Single Digit Weekly Data Code

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

## S1GHE, S1JHE

### THERMAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted) (Note 1)

Symbol	Characteristic	Value	Unit
$\Psi_{\sf JL}$	Junction to Lead Thermal Resistance Thermocouple Soldered to Cathode	26.5	°C/W
$R_{ hetaJA}$	Junction to Ambient Thermal Resistance	200	°C/W

<sup>1.</sup> Per JESD51-3 Recommended Thermal Test Board. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm.

## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{F}$	Instantaneous Forward Voltage (Note 2)	I <sub>F</sub> = 1 A		0.96	1.1	V
I <sub>R</sub>	Reverse Current at Rated V <sub>R</sub>	T <sub>J</sub> = 25°C		0.02	1	μΑ
		T <sub>J</sub> = 125°C		10.35	50	
T <sub>rr</sub>	Reverse Recovery Time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		782		ns
СЈ	Junction Capacitance	V <sub>R</sub> = 4.0 V, f = 1 MHz		3		pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### **ORDERING INFORMATION**

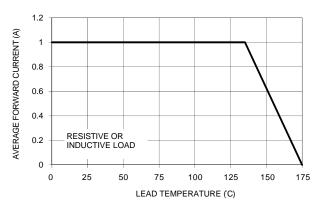
Part Number	Top Mark	Package	Shipping <sup>†</sup>
S1GHE	A5	SOD-323EP (Pb-Free/Halogen Free)	3000 / Tape & Reel
NRVS1GHE			
S1JHE	A7	SOD-323EP	3000 / Tape & Reel
NRVS1JHE		(Pb–Free/Halogen Free)	

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

<sup>2.</sup> Pulse test with PW = 300  $\mu$ s, 1% duty cycle.

## S1GHE, S1JHE

#### TYPICAL PERFORMANCE CHARACTERISTICS



**Figure 1. Forward Current Derating Curve** 

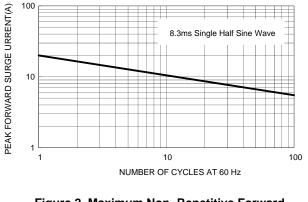


Figure 2. Maximum Non-Repetitive Forward Surge Current

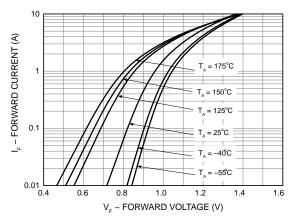
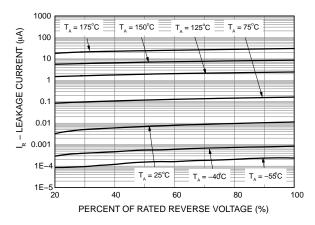


Figure 3. Typical Forward Characteristics



**Figure 4. Typical Reverse Characteristics** 

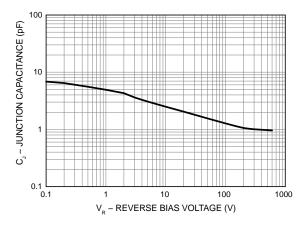


Figure 5. Typical junction Capacitance

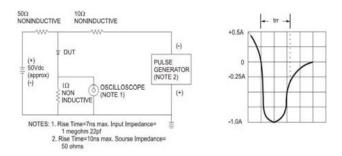
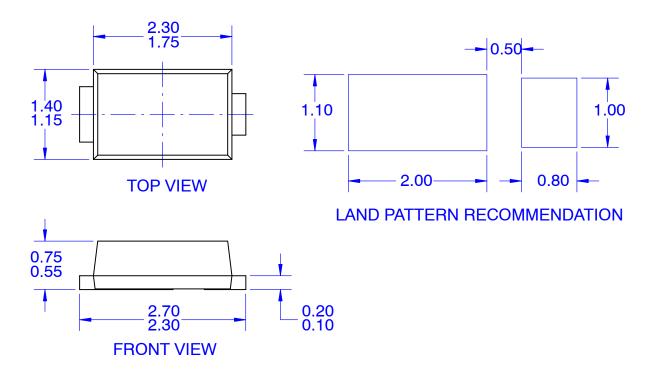


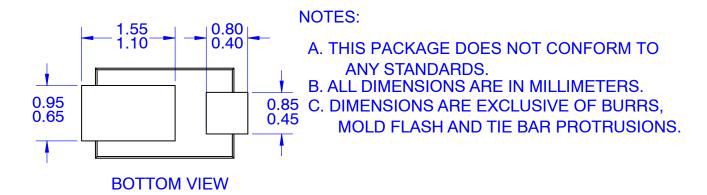
Figure 6. Reverse Recovery Time Characteristics and Test Circuit Diagram



SOD-323EP CASE 477AD ISSUE O

**DATE 31 AUG 2016** 





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